



# BIPOLAR ANALOG INTEGRATED CIRCUIT

## $\mu$ PC8232T5N

### SiGe:C LOW NOISE AMPLIFIER FOR GPS

#### DESCRIPTION

The  $\mu$ PC8232T5N is a silicon germanium carbon (SiGe:C) monolithic integrated circuit designed as low noise amplifier for GPS. This device exhibits low noise figure and high power gain characteristics, so this IC can improve the sensitivity of GPS receiver. In addition, the  $\mu$ PC8232T5N which is included output matching circuit contributes to reduce external components and system size.

The package is a 6-pin plastic TSON (Thin Small Out-line Non-leaded) suitable for surface mount.

This IC is manufactured using our UHS4 (Ultra High Speed Process) SiGe:C bipolar process.

#### FEATURES

- Low noise : NF = 0.95 dB TYP. @  $f_{in}$  = 1 575 MHz
- High gain :  $G_P$  = 17 dB TYP. @  $f_{in}$  = 1 575 MHz
- Low current consumption :  $I_{CC}$  = 3.0 mA TYP. @  $V_{CC}$  = 3.0 V
- Built-in power-saving function
- High-density surface mounting : 6-pin plastic TSON package (1.5 × 1.5 × 0.37 mm)
- Included output matching circuit
- Included very robust bandgap regulator (Small  $V_{CC}$  and  $T_A$  dependence)
- Included protection circuits for ESD

#### APPLICATION

- Low noise amplifier for GPS

#### ORDERING INFORMATION

| Part Number        | Order Number         | Package                         | Marking | Supplying Form   |
|--------------------|----------------------|---------------------------------|---------|--|
| $\mu$ PC8232T5N-E2 | $\mu$ PC8232T5N-E2-A | 6-pin plastic TSON<br>(Pb-Free) | 6L      | <ul style="list-style-type: none"><li>• 8 mm wide embossed taping</li><li>• Pin 1, 6 face the perforation side of the tape</li><li>• Qty 3 kpcs/reel</li></ul> |

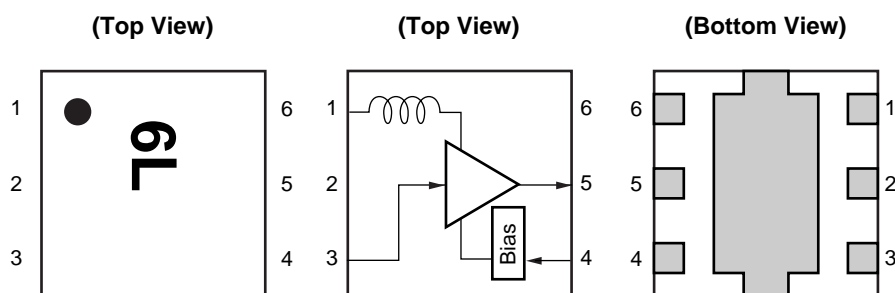
**Remark** To order evaluation samples, contact your nearby sales office.

Part number for sample order:  $\mu$ PC8232T5N-A

**Caution** Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

## PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



| Pin No. | Pin Name        |
|---------|-----------------|
| 1       | V <sub>CC</sub> |
| 2       | GND             |
| 3       | INPUT           |
| 4       | Power Save      |
| 5       | OUTPUT          |
| 6       | V <sub>CC</sub> |

**Remark** Exposed pad : GND

## ABSOLUTE MAXIMUM RATINGS

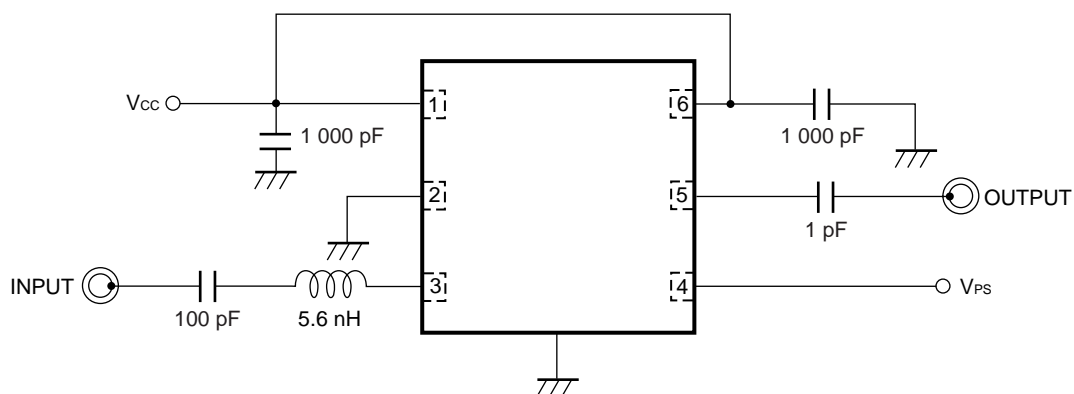
| Parameter                     | Symbol           | Test Conditions        | Ratings     | Unit |
|-------------------------------|------------------|------------------------|-------------|------|
| Supply Voltage                | V <sub>CC</sub>  | T <sub>A</sub> = +25°C | 4.0         | V    |
| Power-Saving Voltage          | V <sub>PS</sub>  | T <sub>A</sub> = +25°C | 4.0         | V    |
| Total Power Dissipation       | P <sub>tot</sub> |                        | 150         | mW   |
| Operating Ambient Temperature | T <sub>A</sub>   |                        | -40 to +85  | °C   |
| Storage Temperature           | T <sub>stg</sub> |                        | -55 to +150 | °C   |
| Input Power                   | P <sub>in</sub>  |                        | +10         | dBm  |

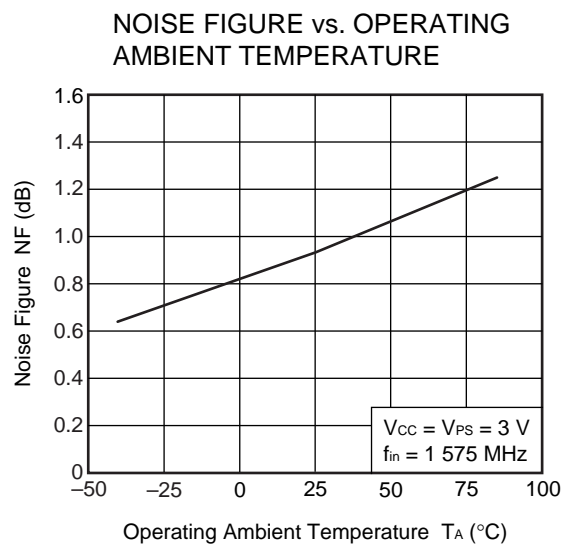
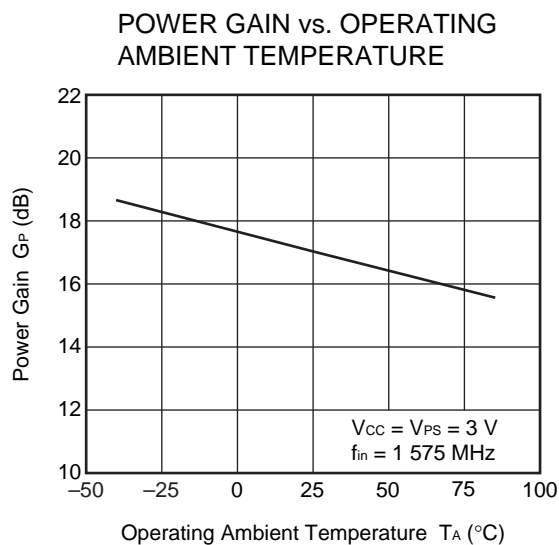
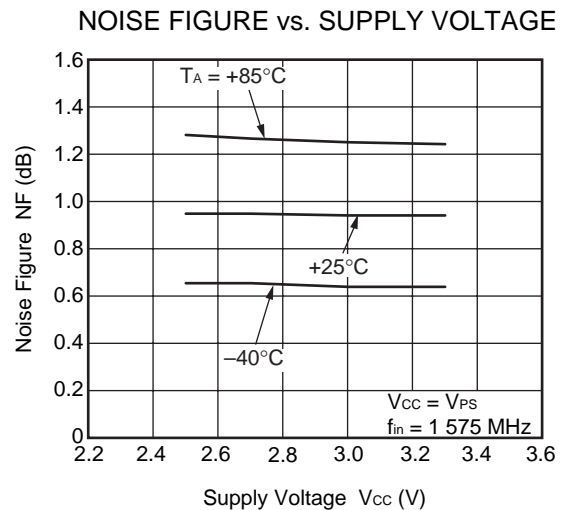
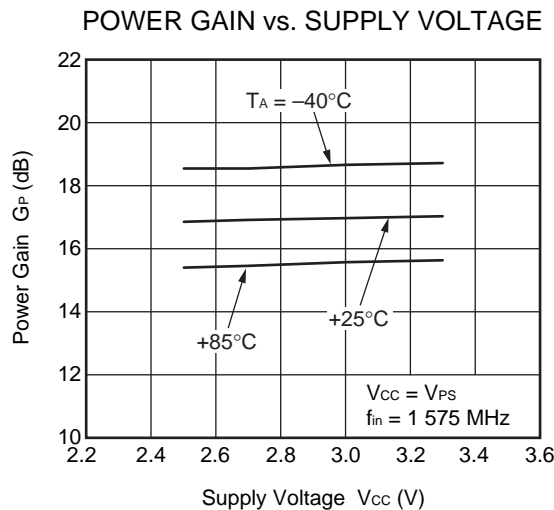
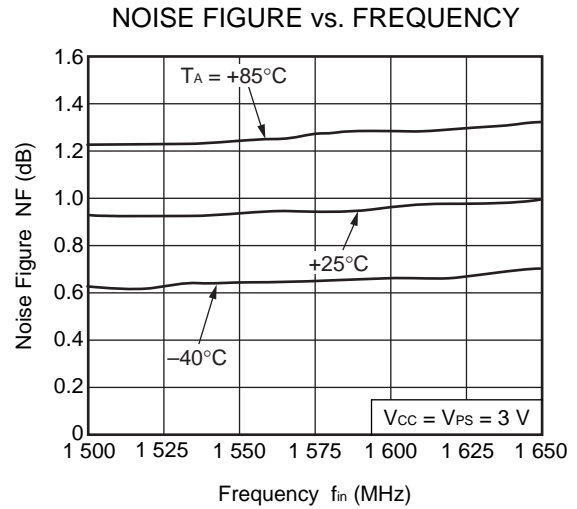
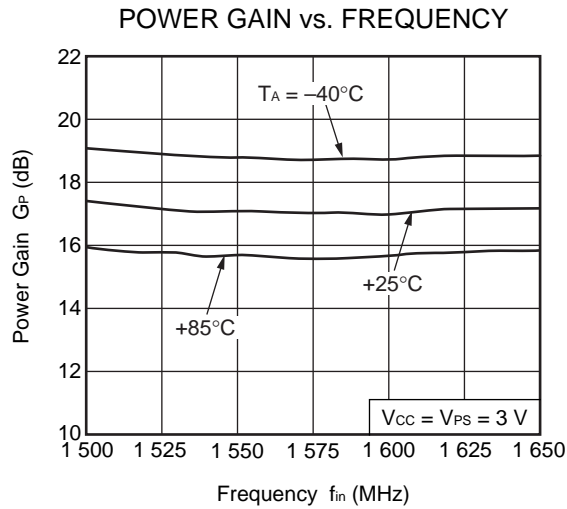
## RECOMMENDED OPERATING RANGE

| Parameter                     | Symbol             | MIN. | TYP. | MAX.            | Unit |
|-------------------------------|--------------------|------|------|-----------------|------|
| Supply Voltage                | V <sub>CC</sub>    | 2.5  | 3.0  | 3.3             | V    |
| Operating Ambient Temperature | T <sub>A</sub>     | -40  | +25  | +85             | °C   |
| Power Save Turn-on Voltage    | V <sub>PSon</sub>  | 1.6  | —    | V <sub>CC</sub> | V    |
| Power Save Turn-off Voltage   | V <sub>PSoff</sub> | 0    | —    | 0.4             | V    |

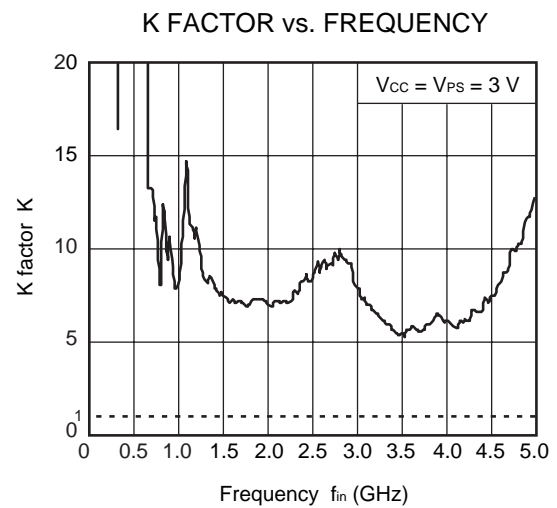
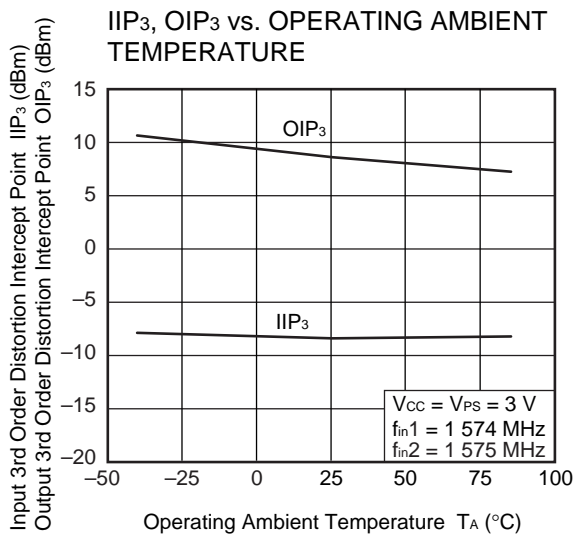
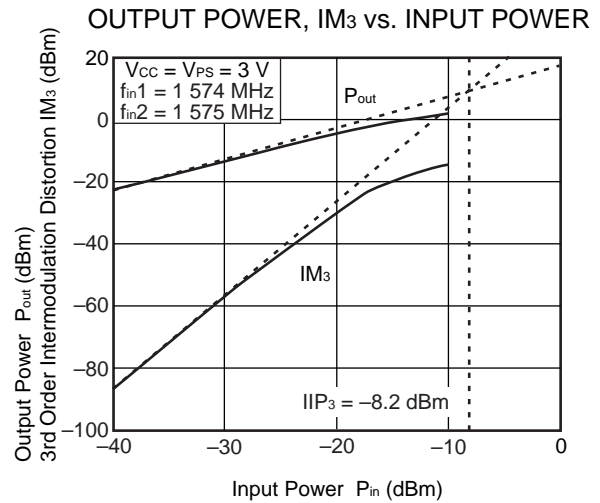
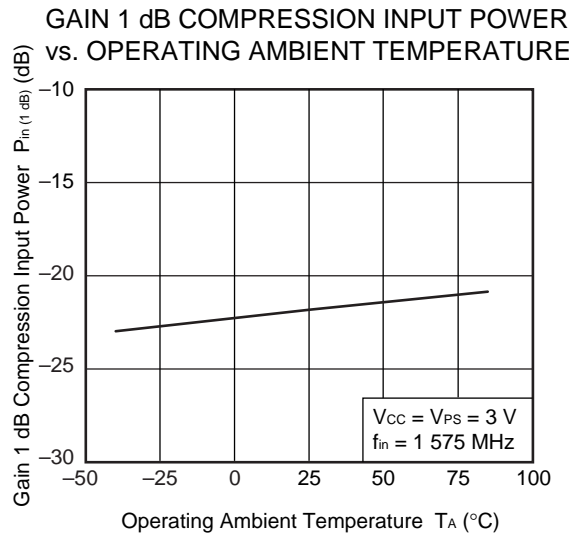
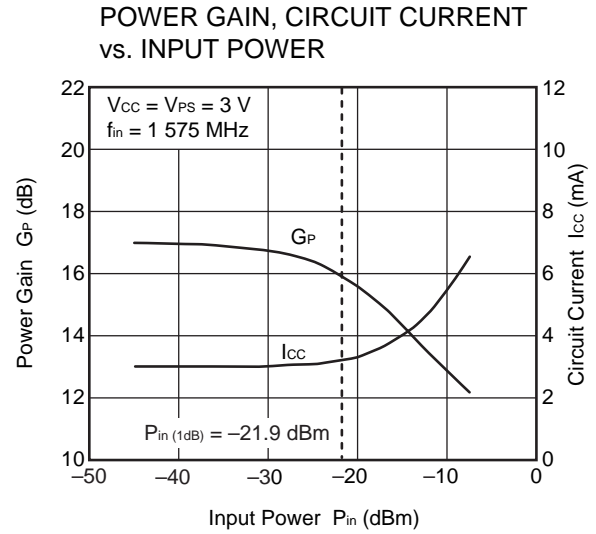
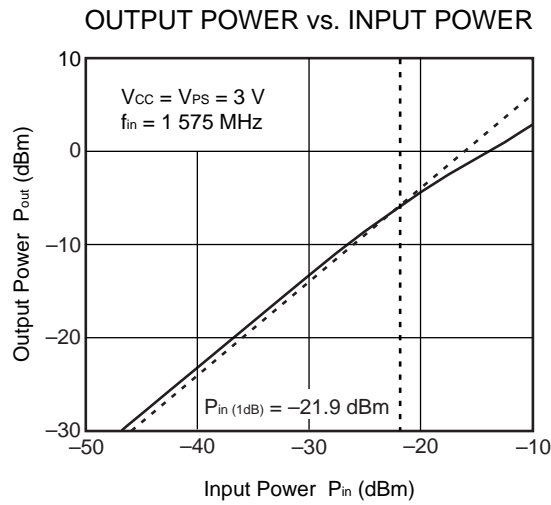
**ELECTRICAL CHARACTERISTICS**(T<sub>A</sub> = +25°C, V<sub>CC</sub> = V<sub>PS</sub> = 3.0 V, f<sub>in</sub> = 1 575 MHz, unless otherwise specified)

| Parameter                                  | Symbol                 | Test Conditions  | MIN. | TYP. | MAX. | Unit |
|--|------------------------|--|------|------|------|------|
| Circuit Current                            | I <sub>CC</sub>        | No Signal (V <sub>PS</sub> = 3.0 V)                        | 2.3  | 3.0  | 4.1  | mA   |
|  |                        | At Power-Saving Mode (V <sub>PS</sub> = 0 V)               | –    | –    | 1    | μA   |
| Power Gain                                 | G <sub>P</sub>         | P <sub>in</sub> = –35 dBm                                  | 15   | 17   | 19   | dB   |
| Noise Figure                               | NF                     |  | –    | 0.95 | 1.25 | dB   |
| Input 3rd Order Distortion Intercept Point | IIP <sub>3</sub>       | f <sub>in1</sub> = 1 574 MHz, f <sub>in2</sub> = 1 575 MHz | –    | –8   | –    | dBm  |
| Input Return Loss                          | RL <sub>in</sub>       |  | 7    | 10   | –    | dB   |
| Output Return Loss                         | RL <sub>out</sub>      |  | 10   | 20   | –    | dB   |
| Isolation                                  | ISL                    |  | –    | 40   | –    | dB   |
| Gain 1 dB Compression Input Power          | P <sub>in</sub> (1 dB) |  | –    | –21  | –    | dBm  |

**TEST CIRCUIT**

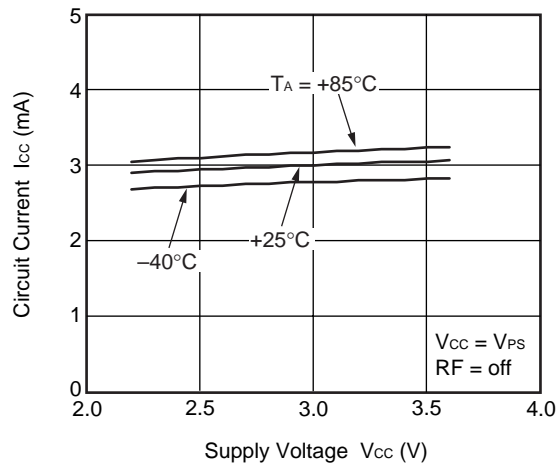
**TYPICAL CHARACTERISTICS ( $T_A = +25^\circ\text{C}$ , unless otherwise specified)**

**Remark** The graphs indicate nominal characteristics.

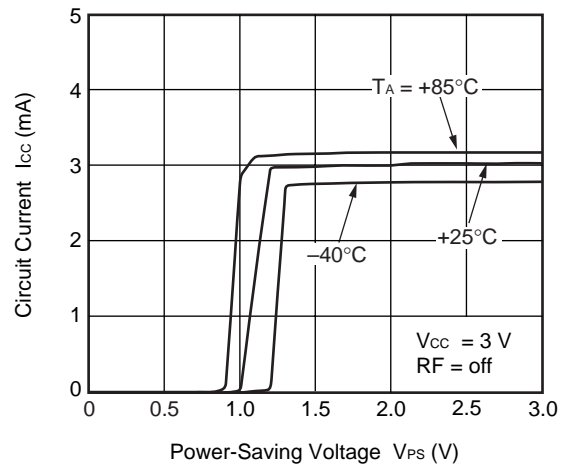


**Remark** The graphs indicate nominal characteristics.

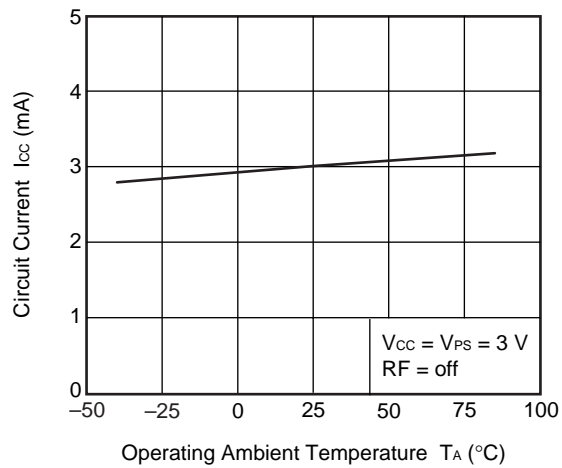
CIRCUIT CURRENT vs. SUPPLY VOLTAGE



CIRCUIT CURRENT vs. POWER-SAVING VOLTAGE



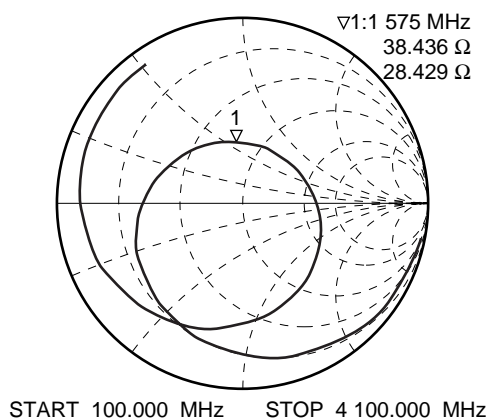
CIRCUIT CURRENT vs. OPERATING AMBIENT TEMPERATURE



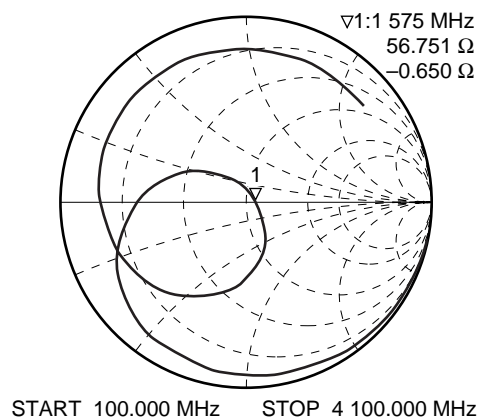
**Remark** The graphs indicate nominal characteristics.

**S-PARAMETERS** ( $T_A = +25^\circ\text{C}$ ,  $V_{CC} = V_{PS} = 3.0\text{ V}$ , monitored at connector on board)

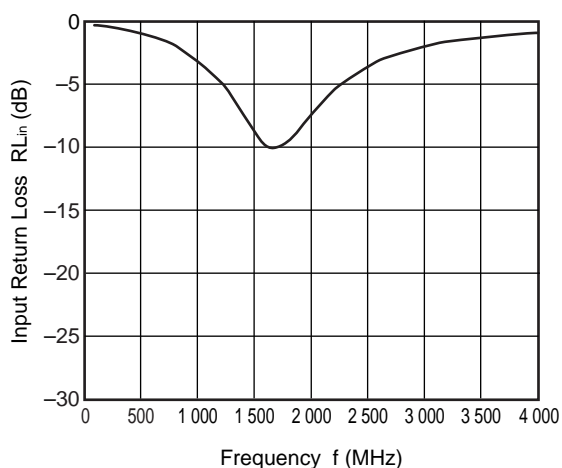
**S<sub>11</sub>—FREQUENCY**



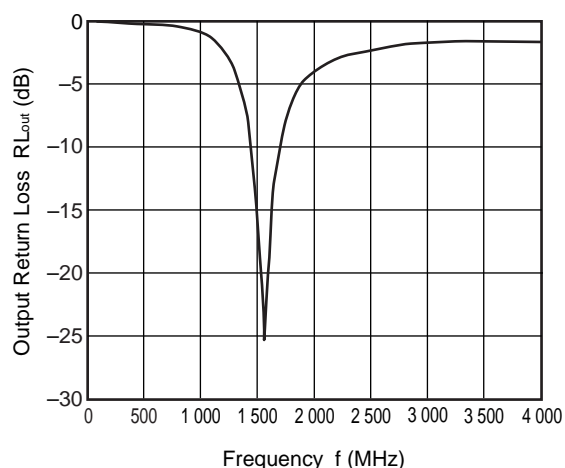
**S<sub>22</sub>—FREQUENCY**



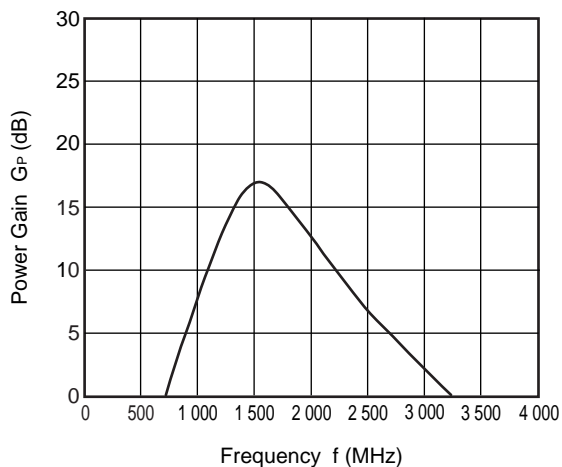
**INPUT RETURN LOSS vs. FREQUENCY**



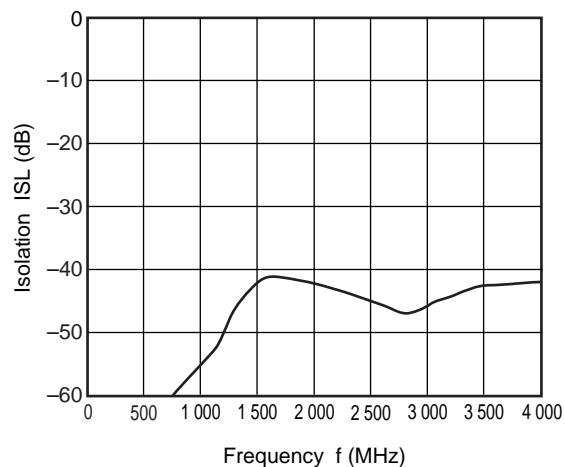
**OUTPUT RETURN LOSS vs. FREQUENCY**



**POWER GAIN vs. FREQUENCY**



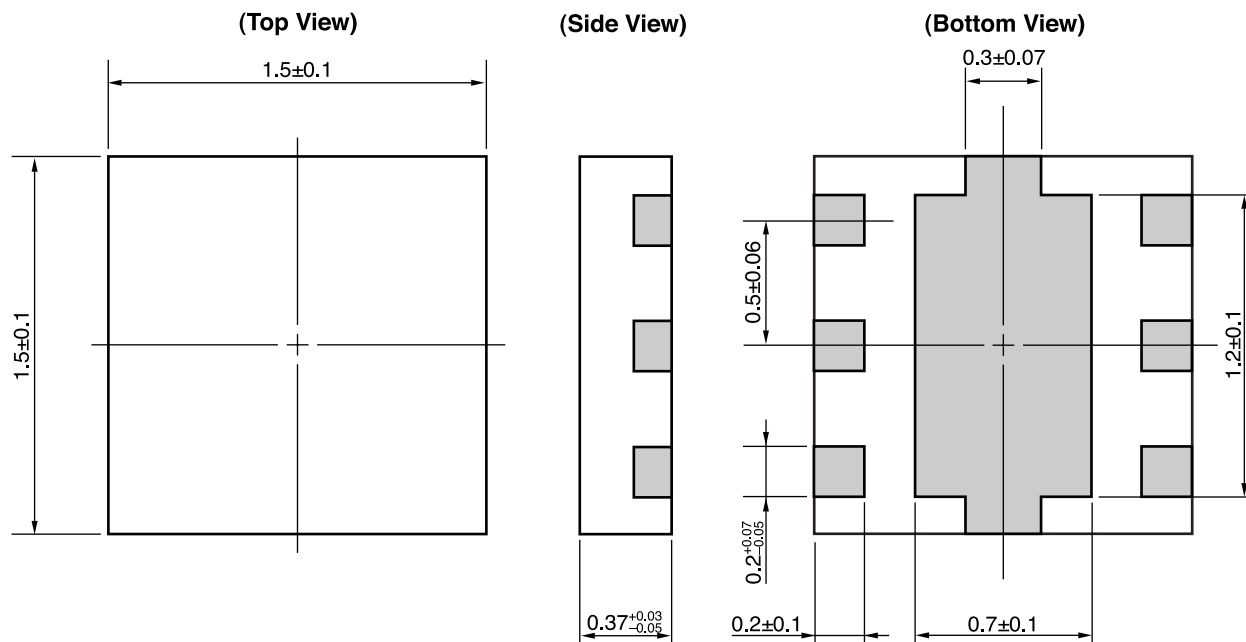
**ISOLATION vs. FREQUENCY**



**Remark** The graphs indicate nominal characteristics.

**PACKAGE DIMENSIONS**

**6-PIN PLASTIC TSON (UNIT: mm)**





**NOTES ON CORRECT USE**

- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as widely as possible to minimize ground impedance (to prevent undesired oscillation).  
All the ground terminals must be connected together with wide ground pattern to decrease impedance difference.
- (3) The bypass capacitor should be attached to Vcc line.
- (4) Do not supply DC voltage to INPUT pin.

**RECOMMENDED SOLDERING CONDITIONS**

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

| Soldering Method | Soldering Conditions  | Condition Symbol |
|------------------|---|------------------|
| Infrared Reflow  | Peak temperature (package surface temperature) : 260°C or below<br>Time at peak temperature : 10 seconds or less<br>Time at temperature of 220°C or higher : 60 seconds or less<br>Preheating time at 120 to 180°C : 120±30 seconds<br>Maximum number of reflow processes : 3 times<br>Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below | IR260            |
| Wave Soldering   | Peak temperature (molten solder temperature) : 260°C or below<br>Time at peak temperature : 10 seconds or less<br>Preheating temperature (package surface temperature) : 120°C or below<br>Maximum number of flow processes : 1 time<br>Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below  | WS260            |
| Partial Heating  | Peak temperature (terminal temperature) : 350°C or below<br>Soldering time (per side of device) : 3 seconds or less<br>Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below   | HS350            |

**Caution** Do not use different soldering methods together (except for partial heating).

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This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

| Restricted Substance per RoHS | Concentration Limit per RoHS (values are not yet fixed) | Concentration contained in CEL devices |     |
|-------------------------------|---|--|-----|
|                               |   | -A                                     | -AZ |
| Lead (Pb)                     | < 1000 PPM  | Not Detected                           | (*) |
| Mercury                       | < 1000 PPM  | Not Detected                           |     |
| Cadmium                       | < 100 PPM   | Not Detected                           |     |
| Hexavalent Chromium           | < 1000 PPM  | Not Detected                           |     |
| PBB                           | < 1000 PPM  | Not Detected                           |     |
| PBDE                          | < 1000 PPM  | Not Detected                           |     |

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